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Details

Product Status	Active
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT
Number of I/O	17
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Through Hole
Package / Case	20-DIP (0.300", 7.62mm)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f0831ph020eg

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Program Memory

The eZ8 CPU supports 64KB of program memory address space. The Z8 Encore! F0830 Series devices contain 1KB to 12KB of on-chip Flash memory in the program memory address space, depending on the device. Reading from program memory addresses outside the available Flash memory address range returns FFH. Writing to these unimplemented program memory addresses produces no effect. Table 6 shows a program memory map for the Z8 Encore! F0830 Series products.

Table 6. Z8 Encore! F0830 Series Program Memory Maps

Program Memory Address (Hex) Function	
Z8F0830 and Z8F0831 Products	
0000–0001	Flash Option Bits
0002–0003	Reset Vector
0004–003D	Interrupt Vectors*
003E–1FFF	Program Memory
Z8F0430 and Z8F0431 Products	
0000–0001	Flash Option Bits
0002–0003	Reset Vector
0004–003D	Interrupt Vectors*
003E–0FFF	Program Memory
Z8F0130 and Z8F0131 Products	
0000–0001	Flash Option Bits
0002–0003	Reset Vector
0004–003D	Interrupt Vectors*
003E–03FF	Program Memory
Z8F0230 and Z8F0231 Products	
0000–0001	Flash Option Bits
0002–0003	Reset Vector
0004–003D	Interrupt Vectors*
003E–07FF	Program Memory
Note: *See Table 34 on page 54 for a list of interrupt vectors.	

clock and reset signals, the required reset duration may be three or four clock periods. A reset pulse of three clock cycles in duration might trigger a reset and a reset pulse of four cycles in duration always triggers a reset.

While the $\overline{\text{RESET}}$ input pin is asserted low, the Z8 Encore! F0830 Series devices remain in the Reset state. If the $\overline{\text{RESET}}$ pin is held low beyond the system reset time-out, the device exits the Reset state on the system clock rising edge following $\overline{\text{RESET}}$ pin deassertion. Following a system reset initiated by the external $\overline{\text{RESET}}$ pin, the EXT status bit in the Reset Status (RSTSTAT) Register is set to 1.

External Reset Indicator

During system reset or when enabled by the GPIO logic, the $\overline{\text{RESET}}$ pin functions as an open-drain (active low) RESET mode indicator in addition to the input functionality. This reset output feature allows an Z8 Encore! F0830 Series device to reset other components to which it is connected, even if that reset is caused by internal sources such as POR, VBO or WDT events. See the [Port A–D Control Registers](#) section on page 41.

After an internal Reset event occurs, the internal circuitry begins driving the $\overline{\text{RESET}}$ pin low. The $\overline{\text{RESET}}$ pin is held low by the internal circuitry until the appropriate delay listed in [Table 9](#) (see page 22) has elapsed.

On-Chip Debugger Initiated Reset

A Power-On Reset can be initiated using the On-Chip Debugger by setting the RST bit in the OCD Control Register. The OCD block is not reset, but the remainder of the chip goes through a normal system reset. The RST bit automatically clears during the system reset. Following the system reset, the POR bit in the Reset Status (RSTSTAT) Register is set.

Stop Mode Recovery

The device enters the STOP Mode when the STOP instruction is executed by the eZ8 CPU. See the [Low-Power Modes](#) chapter on page 30 for detailed STOP Mode information. During Stop Mode Recovery, the CPU is held in reset for about 66 IPO cycles if the crystal oscillator is disabled or about 5000 cycles if it is enabled.

Stop Mode Recovery does not affect the on-chip registers other than the Reset Status (RSTSTAT) Register and the Oscillator Control Register (OSCCTL). After any Stop Mode Recovery, the IPO is enabled and selected as the system clock. If another system clock source is required or IPO disabling is required, the Stop Mode Recovery code must reconfigure the oscillator control block such that the correct system clock source is enabled and selected.

► **Note:** This register is only reset during a Power-On Reset sequence. Other system reset events do not affect it.

Table 14. Power Control Register 0 (PWRCTL0)

Bit	7	6	5	4	3	2	1	0
Field	Reserved			VBO	Reserved	Reserved	COMP	Reserved
RESET	1	0	0	0	1	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F80H							

Bit	Description
[7:5]	Reserved These registers are reserved and must be programmed to 000.
[4] VBO	Voltage Brown-Out detector disable This bit takes only effect when the VBO_AO Flash option bit is disabled. In STOP Mode, VBO is always disabled when the VBO_AO Flash option bit is disabled. To learn more about the VBO_AO Flash option bit function, see the Flash Option Bits chapter on page 124. 0 = VBO enabled. 1 = VBO disabled.
[3]	Reserved This bit is reserved and must be programmed to 1.
[2]	Reserved This bit is reserved and must be programmed to 0.
[1] COMP	Comparator Disable 0 = Comparator is enabled. 1 = Comparator is disabled.
[0]	Reserved This bit is reserved and must be programmed to 0.

Port A–D Alternate Function Set 2 Subregisters

The Port A–D Alternate Function Set 2 Subregister, shown in Table 28, is accessed through the Port A–D Control Register by writing 08H to the Port A–D Address Register. The Alternate Function Set 2 subregisters select the alternate function available at a port pin. Alternate functions selected by setting or clearing bits in this register are defined in Table 16 in the [GPIO Alternate Functions](#) section on page 34.

► **Note:** Alternate function selection on the port pins must also be enabled, as described in the [Port A–D Alternate Function Subregisters](#) section on page 42.

Table 28. Port A–D Alternate Function Set 2 Subregisters (PxAFS2)

Bit	7	6	5	4	3	2	1	0
Field	PAFS27	PAFS26	PAFS25	PAFS24	PAFS23	PAFS22	PAFS21	PAFS20
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	If 08H in Port A–D Address Register, accessible through the Port A–D Control Register							

Bit	Description
[7:0]	Port Alternate Function Set 2
PAFS2x	0 = The Port Alternate function is selected, as defined in Table 16 in the GPIO Alternate Functions section on page 34. 1 = The Port Alternate function is selected, as defined in Table 16 in the GPIO Alternate Functions section on page 34.

Note: x indicates the specific GPIO port pin number (7–0).

Table 39. IRQ0 Enable High Bit Register (IRQ0ENH)

Bit	7	6	5	4	3	2	1	0
Field	Reserved	T1ENH	T0ENH	Reserved				ADCENH
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FC1H							

Bit	Description
[7]	Reserved This bit is reserved and must be programmed to 0.
[6] T1ENH	Timer 1 Interrupt Request Enable High Bit
[5] T0ENH	Timer 0 Interrupt Request Enable High Bit
[4:1]	Reserved These registers are reserved and must be programmed to 0000.
[0] ADCENH	ADC Interrupt Request Enable High Bit

Table 40. IRQ0 Enable Low Bit Register (IRQ0ENL)

Bit	7	6	5	4	3	2	1	0
Field	Reserved	T1ENL	T0ENL	Reserved				ADCENL
RESET	0	0	0	0	0	0	0	0
R/W	R	R/W	R/W	R/W	R/W	R	R	R/W
Address	FC2H							

Bit	Description
[7]	Reserved This bit is reserved and must be programmed to 0.
[6] T1ENL	Timer 1 Interrupt Request Enable Low Bit
[5] T0ENL	Timer 0 Interrupt Request Enable Low Bit
[4:1]	Reserved These registers are reserved and must be programmed to 0000.
[0] ADCENL	ADC Interrupt Request Enable Low Bit

$$\text{PWM Output High Time Ratio (\%)} = \frac{\text{Reload Value} - \text{PWM Value}}{\text{Reload Value}} \times 100$$

If TPOL is set to 1, the ratio of the PWM output high time to the total period is represented by:

$$\text{PWM Output High Time Ratio (\%)} = \frac{\text{PWM Value}}{\text{Reload Value}} \times 100$$

CAPTURE Mode

In CAPTURE Mode, the current timer count value is recorded when the appropriate external timer input transition occurs. The capture count value is written to the timer PWM High and Low Byte registers. The timer input is the system clock. The TPOL bit in the Timer Control Register determines if the capture occurs on a rising edge or a falling edge of the timer input signal.

When the capture event occurs, an interrupt is generated and the timer continues counting. The INPCAP bit in the TxCTL1 Register is set to indicate the timer interrupt because of an input capture event.

The timer continues counting up to the 16-bit reload value stored in the Timer Reload High and Low Byte registers. Upon reaching the reload value, the timer generates an interrupt and continues counting. The INPCAP bit in the TxCTL1 Register clears, indicating that the timer interrupt has not occurred because of an input capture event.

Observe the following steps for configuring a timer for CAPTURE Mode and initiating the count:

1. Write to the Timer Control Register to:
 - Disable the timer
 - Configure the timer for CAPTURE Mode
 - Set the prescale value
 - Set the capture edge (rising or falling) for the timer input
2. Write to the Timer High and Low Byte registers to set the starting count value (typically 0001H).
3. Write to the Timer Reload High and Low Byte registers to set the reload value.
4. Clear the timer PWM High and Low Byte registers to 0000H. Clearing these registers allows user software to determine if interrupts were generated either by a capture event or by a reload. If the PWM High and Low Byte registers still contain 0000H after the interrupt, the interrupt were generated by a reload.

Timer 0–1 PWM High and Low Byte Registers

The Timer 0–1 PWM High and Low Byte (TxPWMH and TxPWML) registers, shown in Tables 54 and 55, control PWM operations. These registers also store the capture values for the CAPTURE and CAPTURE/COMPARE modes.

Table 54. Timer 0–1 PWM High Byte Register (TxPWMH)

Bit	7	6	5	4	3	2	1	0
Field	PWMH							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F04H, F0CH							

Table 55. Timer 0–1 PWM Low Byte Register (TxPWML)

Bit	7	6	5	4	3	2	1	0
Field	PWML							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F05H, F0DH							

Bit	Description
[7:0]	Pulse Width Modulator High and Low Bytes
PWMH, PWML	These two bytes, {PWMH[7:0], PWML[7:0]}, form a 16-bit value that is compared to the current 16-bit timer count. When a match occurs, the PWM output changes state. The PWM output value is set by the TPOL bit in the Timer Control Register (TxCTL1). The TxPWMH and TxPWML registers also store the 16-bit captured timer value when operating in capture or CAPTURE/COMPARE modes.

Flash Option Bits

Programmable Flash option bits allow user configuration of certain aspects of Z8 Encore! F0830 Series operation. The feature configuration data is stored in the Flash program memory and read during reset. The features available for control through the Flash option bits are:

- Watchdog Timer time-out response selection—interrupt or system reset
- Watchdog Timer enabled at reset
- The ability to prevent unwanted read access to user code in program memory
- The ability to prevent accidental programming and erasure of all or a portion of the user code in program memory
- Voltage Brown-Out configuration always enabled or disabled during STOP Mode to reduce STOP Mode power consumption
- OSCILLATOR Mode selection for high, medium and low power crystal oscillators or external RC oscillator
- Factory trimming information for the Internal Precision Oscillator and VBO voltage

Operation

This section describes the type and configuration of the programmable Flash option bits.

Option Bit Configuration by Reset

Each time the Flash option bits are programmed or erased, the device must be reset for the change to be effective. During any Reset operation (system reset or Stop Mode Recovery), the Flash option bits are automatically read from Flash program memory and written to the Option Configuration registers, which control Z8 Encore! F0830 Series device operation. Option bit control is established before the device exits reset and the eZ8 CPU begins code execution. The Option Configuration registers are not part of the register file and are not accessible for read or write access.

Nonvolatile Data Storage

Z8 Encore! F0830 Series devices contain a Nonvolatile Data Storage (NVDS) element of up to 64 bytes (except when in Flash 12KB mode). This type of memory can perform over 100,000 write cycles.

Operation

NVDS is implemented by special-purpose Zilog software stored in areas of program memory that are not user-accessible. These special-purpose routines use Flash memory to store the data, and incorporate a dynamic addressing scheme to maximize the write/erase endurance of the Flash.

► **Note:** The products in the Z8 Encore! F0830 Series feature multiple NVDS array sizes. See the Z8 Encore! F0830 Series Family Part Selection Guide section on page 2 for details.

NVDS Code Interface

Two routines are required to access the NVDS: a write routine and a read routine. Both of these routines are accessed with a CALL instruction to a predefined address outside of program memory that is accessible to the user. Both the NVDS address and data are single-byte values. In order to not disturb the user code, these routines save the working register set before using it so that 16 bytes of stack space are required to preserve the site. After finishing the call to these routines, the working register set of the user code is recovered.

During both read and write accesses to the NVDS, interrupt service is not disabled. Any interrupts that occur during NVDS execution must not disturb the working register and existing stack contents; otherwise, the array can become corrupted. Zilog recommends the user disable interrupts before executing NVDS operations.

Use of the NVDS requires 16 bytes of available stack space. The contents of the working register set are saved before calling NVDS read or write routines.

For correct NVDS operation, the Flash Frequency registers must be programmed based on the system clock frequency. See the Flash Operation Timing Using the Flash Frequency Registers section on page 114.

When selecting a new clock source, the primary oscillator failure detection circuitry and the Watchdog Timer Oscillator failure circuitry must be disabled. If POFEN and WOFEN are not disabled prior to a clock switch-over, it is possible to generate an interrupt for a failure of either oscillator. The failure detection circuitry can be enabled anytime after a successful write of OSCSEL in the Oscillator Control Register.

The Internal Precision Oscillator is enabled by default. If the user code changes to a different oscillator, it may be appropriate to disable the IPO for power savings. Disabling the IPO does not occur automatically.

Clock Failure Detection and Recovery

Primary Oscillator Failure

The Z8F04xA family devices can generate nonmaskable interrupt-like events when the primary oscillator fails. To maintain system function in this situation, the clock failure recovery circuitry automatically forces the Watchdog Timer Oscillator to drive the system clock. The Watchdog Timer Oscillator must be enabled to allow the recovery. Although this oscillator runs at a much slower speed than the original system clock, the CPU continues to operate, allowing execution of a clock failure vector and software routines that either remedy the oscillator failure or issue a failure alert. This automatic switch-over is not available if the Watchdog Timer is the primary oscillator. It is also unavailable if the Watchdog Timer Oscillator is disabled, though it is not necessary to enable the Watchdog Timer reset function outlined in the Watchdog Timer chapter of this document.

The primary oscillator failure detection circuitry asserts if the system clock frequency drops below 1 KHz $\pm 50\%$. If an external signal is selected as the system oscillator, it is possible that a very slow but nonfailing clock can generate a failure condition. Under these conditions, do not enable the clock failure circuitry (POFEN must be deasserted in the OSCCTL Register).

Watchdog Timer Failure

In the event of failure of a Watchdog Timer Oscillator, a similar nonmaskable interrupt-like event is issued. This event does not trigger an attendant clock switch-over, but alerts the CPU of the failure. After a Watchdog Timer failure, it is no longer possible to detect a primary oscillator failure. The failure detection circuitry does not function if the Watchdog Timer is used as the primary oscillator or if the Watchdog Timer Oscillator has been disabled. For either of these cases, it is necessary to disable the detection circuitry by deasserting the WDFEN bit of the OSCCTL Register.

The Watchdog Timer Oscillator failure detection circuit counts system clocks while looking for a Watchdog Timer clock. The logic counts 8004 system clock cycles before determining that a failure has occurred. The system clock rate determines the speed at which the Watchdog Timer failure is detected. A very slow system clock results in very slow detection times.

Bit	Description (Continued)
[4] POFEN	Primary Oscillator Failure Detection Enable 1 = Failure detection and recovery of primary oscillator is enabled. 0 = Failure detection and recovery of primary oscillator is disabled.
[3] WDFEN	Watchdog Timer Oscillator Failure Detection Enable 1 = Failure detection of Watchdog Timer Oscillator is enabled. 0 = Failure detection of Watchdog Timer Oscillator is disabled.
[2:0] SCKSEL	System Clock Oscillator Select 000 = Internal Precision Oscillator functions as system clock at 5.53MHz. 001 = Internal Precision Oscillator functions as system clock at 32 kHz. 010 = Crystal oscillator or external RC oscillator functions as system clock. 011 = Watchdog Timer Oscillator functions as system clock. 100 = External clock signal on PB3 functions as system clock. 101 = Reserved. 110 = Reserved. 111 = Reserved.

Example 2

In general, when an instruction format requires an 8-bit register address, the address can specify any register location in the range 0–255 or, using escaped mode addressing, a working register R0–R15. If the contents of register 43H and working register R8 are added and the result is stored in 43H, the assembly syntax and resulting object code is:

Table 102. Assembly Language Syntax Example 2

Assembly Language Code	ADD	43H,	R8	(ADD dst, src)
Object Code	04	E8	43	(OPC src, dst)

See the device specific product specification to determine the exact register file range available. The register file size varies, depending on the device type.

eZ8 CPU Instruction Notation

In the eZ8 CPU instruction summary and description sections, the operands, condition codes, status flags and address modes are represented by the notational shorthand listed in Table 103.

Table 103. Notational Shorthand

Notation	Description	Operand	Range
b	Bit	b	b represents a value from 0 to 7 (000B to 111B).
cc	Condition Code	—	See condition codes overview in the eZ8 CPU User Manual.
DA	Direct Address	AddrS	AddrS. represents a number in the range of 0000H to FFFFH
ER	Extended Addressing Register	Reg	Reg. represents a number in the range of 000H to FFFH
IM	Immediate Data	#Data	Data is a number between 00H to FFH
Ir	Indirect Working Register	@Rn	n = 0 –15
IR	Indirect Register	@Reg	Reg. represents a number in the range of 00H to FFH
Irr	Indirect Working Register Pair	@RRp	p = 0, 2, 4, 6, 8, 10, 12 or 14
IRR	Indirect Register Pair	@Reg	Reg. represents an even number in the range 00H to FEH
p	Polarity	p	Polarity is a single bit binary value of either 0B or 1B.
r	Working Register	Rn	n = 0 – 15

Table 113. eZ8 CPU Instruction Summary (Continued)

Assembly Mnemonic	Symbolic Operation	Address Mode		Op Code(s) (Hex)	Flags						Fetch Cycles	Instr. Cycles
		dst	src		C	Z	S	V	D	H		
AND dst, src	$\text{dst} \leftarrow \text{dst AND src}$	r	r	52	–	*	*	0	–	–	2	3
		r	lr	53							2	4
		R	R	54							3	3
		R	IR	55							3	4
		R	IM	56							3	3
		IR	IM	57							3	4
ANDX dst, src	$\text{dst} \leftarrow \text{dst AND src}$	ER	ER	58	–	*	*	0	–	–	4	3
		ER	IM	59							4	3
ATM	Block all interrupt and DMA requests during execution of the next 3 instructions			2F	–	–	–	–	–	–	1	2
BCLR bit, dst	$\text{dst}[\text{bit}] \leftarrow 0$	r		E2	–	*	*	0	–	–	2	2
BIT p, bit, dst	$\text{dst}[\text{bit}] \leftarrow \text{p}$	r		E2	–	*	*	0	–	–	2	2
BRK	Debugger Break			00	–	–	–	–	–	–	1	1
BSET bit, dst	$\text{dst}[\text{bit}] \leftarrow 1$	r		E2	–	*	*	0	–	–	2	2
BSWAP dst	$\text{dst}[7:0] \leftarrow \text{dst}[0:7]$	R		D5	X	*	*	0	–	–	2	2
BTJ p, bit, src, dst	if $\text{src}[\text{bit}] = \text{p}$ $\text{PC} \leftarrow \text{PC} + \text{X}$		r	F6	–	–	–	–	–	–	3	3
			lr	F7							3	4
BTJNZ bit, src, dst	if $\text{src}[\text{bit}] = 1$ $\text{PC} \leftarrow \text{PC} + \text{X}$		r	F6	–	–	–	–	–	–	3	3
			lr	F7							3	4
BTJZ bit, src, dst	if $\text{src}[\text{bit}] = 0$ $\text{PC} \leftarrow \text{PC} + \text{X}$		r	F6	–	–	–	–	–	–	3	3
			lr	F7							3	4
CALL dst	$\text{SP} \leftarrow \text{SP} - 2$	IRR		D4	–	–	–	–	–	–	2	6
	@SP $\leftarrow \text{PC}$ $\text{PC} \leftarrow \text{dst}$	DA		D6							3	3
CCF	$\text{C} \leftarrow \sim \text{C}$			EF	*	–	–	–	–	–	1	2

Note: Flags Notation:

* = Value is a function of the result of the operation.

– = Unaffected.

X = Undefined.

0 = Reset to 0.

1 = Set to 1.

Table 128. Z8 Encore! XP F0830 Series Ordering Matrix

Part Number	Flash	RAM	NVDS	ADC Channels	Description
Z8F0131PJ020SG	1KB	256	Yes	0	PDIP 28-pin
Z8F0131QJ020SG	1KB	256	Yes	0	QFN 28-pin
Extended Temperature: –40°C to 105°C					
Z8F0130SH020EG	1KB	256	Yes	7	SOIC 20-pin
Z8F0130HH020EG	1KB	256	Yes	7	SSOP 20-pin
Z8F0130PH020EG	1KB	256	Yes	7	PDIP 20-pin
Z8F0130QH020EG	1KB	256	Yes	7	QFN 20-pin
Z8F0131SH020EG	1KB	256	Yes	0	SOIC 20-pin
Z8F0131HH020EG	1KB	256	Yes	0	SSOP 20-pin
Z8F0131PH020EG	1KB	256	Yes	0	PDIP 20-pin
Z8F0131QH020EG	1KB	256	Yes	0	QFN 20-pin
Z8F0130SJ020EG	1KB	256	Yes	8	SOIC 28-pin
Z8F0130HJ020EG	1KB	256	Yes	8	SSOP 28-pin
Z8F0130PJ020EG	1KB	256	Yes	8	PDIP 28-pin
Z8F0130QJ020EG	1KB	256	Yes	8	QFN 28-pin
Z8F0131SJ020EG	1KB	256	Yes	0	SOIC 28-pin
Z8F0131HJ020EG	1KB	256	Yes	0	SSOP 28-pin
Z8F0131PJ020EG	1KB	256	Yes	0	PDIP 28-pin
Z8F0131QJ020EG	1KB	256	Yes	0	QFN 28-pin
ZUSBSC00100ZACG					USB Smart Cable Accessory Kit
ZUSBOPTSC01ZACG					Opto-Isolated USB Smart Cable Accessory Kit

Part Number Suffix Designations

Zilog part numbers consist of a number of components, as indicated in the following example.

Example. Part number Z8F0830SH020SG is an 8-bit 20MHz Flash MCU with 8KB Program Memory and equipped with ADC and NVDS in a 20-pin SOIC package, operating within a 0°C to +70°C temperature range and built using lead-free solder.

Hex Address: F05

Table 135. Timer 0 PWM Low Byte Register (T0PWML)

Bit	7	6	5	4	3	2	1	0
Field	PWML							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F05H							

Hex Address: F06

Table 136. Timer 0 Control Register 0 (T0CTL0)

Bit	7	6	5	4	3	2	1	0
Field	TMODEHI	TICONFIG		Reserved	PWMD			INPCAP
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F06H							

Hex Address: F07

Table 137. Timer 0 Control Register 1 (T0CTL1)

Bit	7	6	5	4	3	2	1	0
Field	TEN	TPOL	PRES			TMODE		
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F07H							

Hex Address: F08

Table 138. Timer 1 High Byte Register (T1H)

Bit	7	6	5	4	3	2	1	0
Field	TH							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F08H							

Hex Address: F71

This address range is reserved.

Hex Address: F72

Table 147. ADC Data High Byte Register (ADCD_H)

Bit	7	6	5	4	3	2	1	0
Field	ADCDH							
RESET	X							
R/W	R							
Address	F72H							

Bit	Description
[7:0]	ADC High Byte 00h–FFh = The last conversion output is held in the data registers until the next ADC conversion is completed.

Hex Address: F73

Table 148. ADC Data Low Bits Register (ADCD_L)

Bit	7	6	5	4	3	2	1	0
Field	ADCDL		Reserved					
RESET	X		X					
R/W	R		R					
Address	F73H							

Bit Position	Description
[7:6]	ADC Low Bits 00–11b = These bits are the two least significant bits of the 10-bit ADC output. These bits are undefined after a reset. The low bits are latched into this register whenever the ADC Data High Byte Register is read.
[5:0]	Reserved These bits are reserved and must be programmed to 000000.

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